

# Radiation hard sensors for ILC forward calorimeter

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Two calorimeters: LumiCal for Lumi measurement with Bhabha Covers angle ~30 (40) to 80 (100) mrad

Two calorimeters:

BeamCal for low angle hermeticity. Possibly to estimate beam parameters. Covers angle ~5 (10) to 40 mrad

Developed by FCAL collaboration since TESLA







EM calorimeter with sandwich structure: 30 layers of 1  $X_{0,}$ 3.5mm W and 0.3mm sensor, Moliére radius  $R_M \approx 1$  cm



Beamstrahlung (beam-beam interaction) => Coherent and incoherent pairs => Hit BeamCal It is possible to extract some information on beam parameters from pair distribution. See. Ch. Grah and A. Sapronov Beam parameter determination using beamstrahlung photons and incoherent pairs

Max expected dose about 1 MGy per year of operation (3TeV CLIC), or ~0.5 (ILC). Background from beamstrahlung-generated pairs. Mostly EM, energy ~ 10 MeV (showers). Radiation hard sensors required, cooling is difficult.



Particle knocks atoms out of the crystal lattice – introduces defects These defects could act in different ways



+ surface effects (charge trapping in SiO<sub>2</sub>) affects electronics



#### Gallium arsenide (GaAs), Polycrystalline CVD (chemical vapour deposition) Diamond (pCVD) Single crystall CVD Diamond (sCVD) Sapphire

		GaAs	Si	Diamond	Sapphire
	Density	5.32 g/cm <sup>3</sup>	2.33	3.51	3.98
•	Pair creation E	4.3 eV/pair	3.6	13	24.6
•	Band gap	1.42 eV	1.14	5.47	9.9
•	Electron mobility	8500 cm <sup>2</sup> /Vs	1350	2200	>600
	Hole mobility	400 cm <sup>2</sup> /Vs	450	1600	-
•	Dielectric const.	12.85	11.9	5.7	9.3-11.5
•	Radiation length	2.3 cm	9.4	18.8	
	Ave. E <sub>dep</sub> /100 µm				
	(by 10 MeV e <sup>-</sup> )	69.7 keV	53.3	34.3	
	MPV pairs/100 µm	15000	7200	3600	2200
	Structure	p-n or insul.	p-n	insul.	insul.



### pCVD Diamond

- pCVD diamond:
  - radiation hard
  - Good properties : high mobility, low  $\varepsilon_R = 5.7$ , thermal conductivity
  - availability on wafer scale
- Samples investigated:
  - Element Six (ex-DeBeers)
  - $-1 \times 1 \text{ cm}^2$
  - 200-500 μm thick
     (typical thickness 300μm)
  - Ti(/Pt)/Au metallization

(courtesy of IAF) 2" (courtesy of IAF)

The only problem is that there is only one main detector-grade material manufacturer Price is still too high for large-scale application





10 MGy for diamond roughly correspond to 10<sup>16</sup> n/cm<sup>-2</sup> for Si





Signal decreased by ~ 80 % after absorbed dose of about 7 MGy

Slight increase in dark current, but still in pA range



Single crystal CVD (chemical vapour deposition) diamond CVD growth on top of diamond substrate

- + Low defect content, very good detector properties
- Small area (up to 5x5 mm), very high price

#### Sample produced by Element Six

5x5 mm,  $320\mu$ m thickness

initial charge collection efficiency about 100% (CCD 320 $\mu$ m)











#### Diamond detector application. CMS beam monitoring





#### GaAs Detector

Supplied by FCAL group at JINR Produced in Tomsk

Sample is semi-insulating GaAs doped by Sn (shallow donor) and compensated by Cr (deep acceptor). This is done to compensate electron trapping centers EL2+ and provide *i*-type conductivity. Charge transport by electrons only. CCE ~ 50% by default.

Sample works as a solid state ionisation chamber Structure provided by metallisation (similar to diamond) 500  $\mu$ m thick detector is divided into 87 5x5 mm pads and mounted on a 0.5mm PCB with fanout Metallisation is V (30 nm) + Au (1  $\mu$ m)



#### GaAs. Irradiation results. CCE



<u>Results: CCE dropped to about 5% from ~50% after 1.5 MGy</u> this corresponds to signal size of about 2000 e<sup>-</sup> No saturation, signal could be increased with bias voltage



GaAs. Irradiation results. Dark current



Dark current increased  $\approx 2$  times (from 0.4 to 1  $\mu$ A @ 200V)

Signal is still visible for an absorbed dose of about 1.5 MGy



Single crystal  $Al_2O_3$  grown by Czochralski process Large scale production: crystals up to 500 kg Positive: Cheap, large area, wide bandgap Negative: small response to MIPs (~2200 eh pairs per 100 um) Low charge collection efficiency (~5%) => signal from MIP in Typical 500 um detector ~500 e









Response measured in current mode. Good radiation hardness Dark current ~pA before and after irradiation







RD 50 collaboration (www.cern.ch/rd50/) since 2003
> 300 members working on radiation hard silicon detectors
Goal => Silicon detectors able to withstand fluence up to 10<sup>16</sup> 1 MeV neutron equivalent per cm<sup>-2</sup> (this was demonstrated recently, switch to p-type silicon)
New Goal (next 5 years) => Silicon detectors able to withstand fluence up to 10<sup>17</sup> 1 MeV neutron equivalent per cm<sup>-2</sup> (FCC and HL LHC requirements)

A working group WODEAN (Workshop on Defect Analysis in Silicon Detectors)

RD 50 mostly study strip and pixel detectors. Hadronic irradiation



Dark current rises linearly with the fluence



This means for 10x10x0.3 mm detector Idark ~ 1 mA @ room temp. => Needs cooling to at least -20C and up to -50C (still uA currents)





Signal is visible after  $10^{16}$  n/cm<sup>-2</sup>, but V<sub>fd</sub> goes into kilovolt range Needs at least 1kV bias (no full depletion) and cooling



## THANK YOU



#### Silicon. Motivation and who is doing it

#### Planned upgrade of the LHC in ~ 2022: Fluence of all hadrons in n<sub>eq</sub>/cm<sup>2</sup> (Data by I. Dawson) 100 100 10<sup>17</sup>



Expected particle fluences for the ATLAS Inner tracker: \_\_\_\_\_all hadrons



- protons

— pions

Similar for CMS

3000 fb<sup>-1</sup> expected integrated luminosity
high radiation exposure to the tracking detector:

2\*10<sup>16</sup> neq/cm<sup>2</sup> for inner pixel layers up to 1\*10<sup>15</sup> neq/cm<sup>2</sup> in the strip region

